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High Brightness LED Power Module



22454



22159

DESCRIPTION

The VLSL3212A2, VLSL3224A2 are metal core based high brightness LED power modules, assembled with 12 or 24 HB white LEDs. The color temperature is warm white. The typical color temperature is 3500 K. The modules are designed for flexible use due to the option for using special reflectors to adjust the emission characteristics.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: LED module
- Product series: power
- Angle of half intensity: $\pm 80^\circ$

PARTS TABLE				
PART	COLOR	LUMINOUS FLUX (at $I_F = 700$ mA typ.)	COLOR TEMPERATURE K	TECHNOLOGY
VLSL3212A2	Warm white	$\Phi_V = 1500$ lm	typ. 3500	InGaN
VLSL3224A2	Warm white	$\Phi_V = 3000$ lm	typ. 3500	InGaN

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified) VLSL3212A2, VLSL3224A2				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward current	Per row	I_F	750	mA
Power dissipation VLSL3212A2	Total (max.)	P_{tot}	34.5	W
Power dissipation VLSL3224A2		P_{tot}	69	W
Junction temperature		T_j	120	$^\circ\text{C}$
Operating temperature range		T_{amb}	- 40 to + 85	$^\circ\text{C}$
Storage temperature range		T_{stg}	- 40 to + 85	$^\circ\text{C}$

FEATURES

- Metal core PCB: Al > 0.75 thickness
- Single side/single layer PCB
- Shiny white surface
- 12 or 24 LEDs minimum 61 lm at 350 mA per LED. Max. current per LED 1 A
- Conductive top layer: Cu (min. 18 μm)
- Isolation layer prepreg > 63 μm
- Standard solder mask material
- ESD withstand voltage: up to 2 kV according to JESD22-A114-B
- LM80 certified LEDs
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Streetlight
- Internal lighting in buildings
- Tunnel lights
- General lighting application

** Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) VLSL3212A2, WARM WHITE

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous flux per row ⁽¹⁾	$I_F = 700\text{ mA}$	Φ_V	550	750	-	lm
Luminous flux total ⁽¹⁾	$I_{board} = 2 \times 700\text{ mA}$	Φ_V	1100	1500	-	lm
Color temperature	$I_F = 700\text{ mA}$	TK	-	3500	-	K
Forward voltage per row	$I_F = 700\text{ mA}$	V_F	19	21	23	V
Class A ($V_{Fmax.} - V_{Fmin.}$) all rows ⁽²⁾	$I_F = 700\text{ mA}$	ΔV_F	-	-	0.9	V
Temperature coefficient of V_F per row	$I_F = 350\text{ mA}$	TC_{V_F}	-	- 20	-	mV/K
Temperature coefficient of Φ_V	$I_F = 350\text{ mA}$ (per row)	TC_{Φ_V}	-	- 0.4	-	%/K

Notes

- Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of $\pm 0.1\text{ V}$. Luminous flux is measured at a current pulse duration of 25 ms and an accuracy of $\pm 11\%$.
- ⁽¹⁾ Calculated based on single LED unit.
- ⁽²⁾ V_F classes are marked at the LED cluster and represent the technical classification only. The single groups cannot be specifically ordered.

OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) VLSL3224A2, WARM WHITE

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous flux per row ⁽¹⁾	$I_F = 700\text{ mA}$	Φ_V	550	750	-	lm
Luminous flux total ⁽¹⁾	$I_{board} = 4 \times 700\text{ mA}$	Φ_V	2200	3000	-	lm
Color temperature	$I_F = 700\text{ mA}$	TK	-	3500	-	K
Forward voltage per row	$I_F = 700\text{ mA}$	V_F	19	21	23	V
Class A ($V_{Fmax.} - V_{Fmin.}$) all rows ⁽²⁾	$I_F = 700\text{ mA}$	ΔV_F	-	-	0.9	V
Temperature coefficient of V_F per row	$I_F = 350\text{ mA}$	TC_{V_F}	-	- 20	-	mV/K
Temperature coefficient of Φ_V	$I_F = 350\text{ mA}$ (per row)	TC_{Φ_V}	-	- 0.4	-	%/K

Notes

- Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of $\pm 0.1\text{ V}$. Luminous flux is measured at a current pulse duration of 25 ms and an accuracy of $\pm 11\%$.
- ⁽¹⁾ Calculated based on single LED unit.
- ⁽²⁾ V_F classes are marked at the LED cluster and represent the technical classification only. The single groups cannot be specifically ordered.

LUMINOUS FLUX CLASSIFICATION FOR THE SINGLE LED AT 350 mA

GROUP	LUMINOUS FLUX Φ_V (mIm) CORRELATION TABLE	
	MIN.	MAX.
STANDARD		
JZ	61 000	71 000
KX	71 000	82 000
KY	82 000	97 000
KZ	97 000	112 000



COLOR RANGE AND COLOR BINNING

VLSL3212A2, VLSL3224A2: typ. 3500 K; group 4O to 9Q

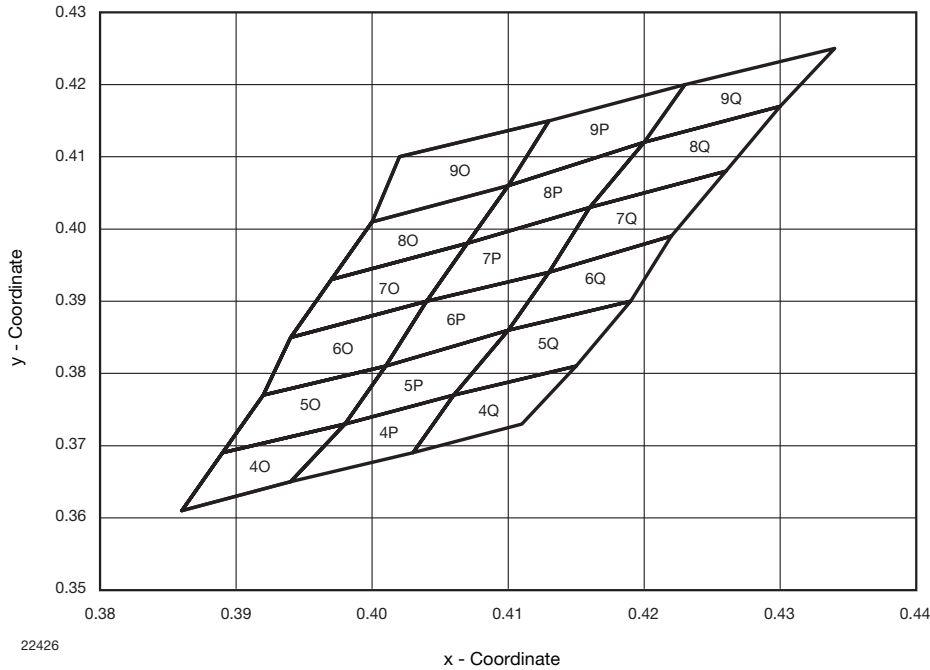


Fig. 1 - Chromaticity Coordinates of Colorgroups

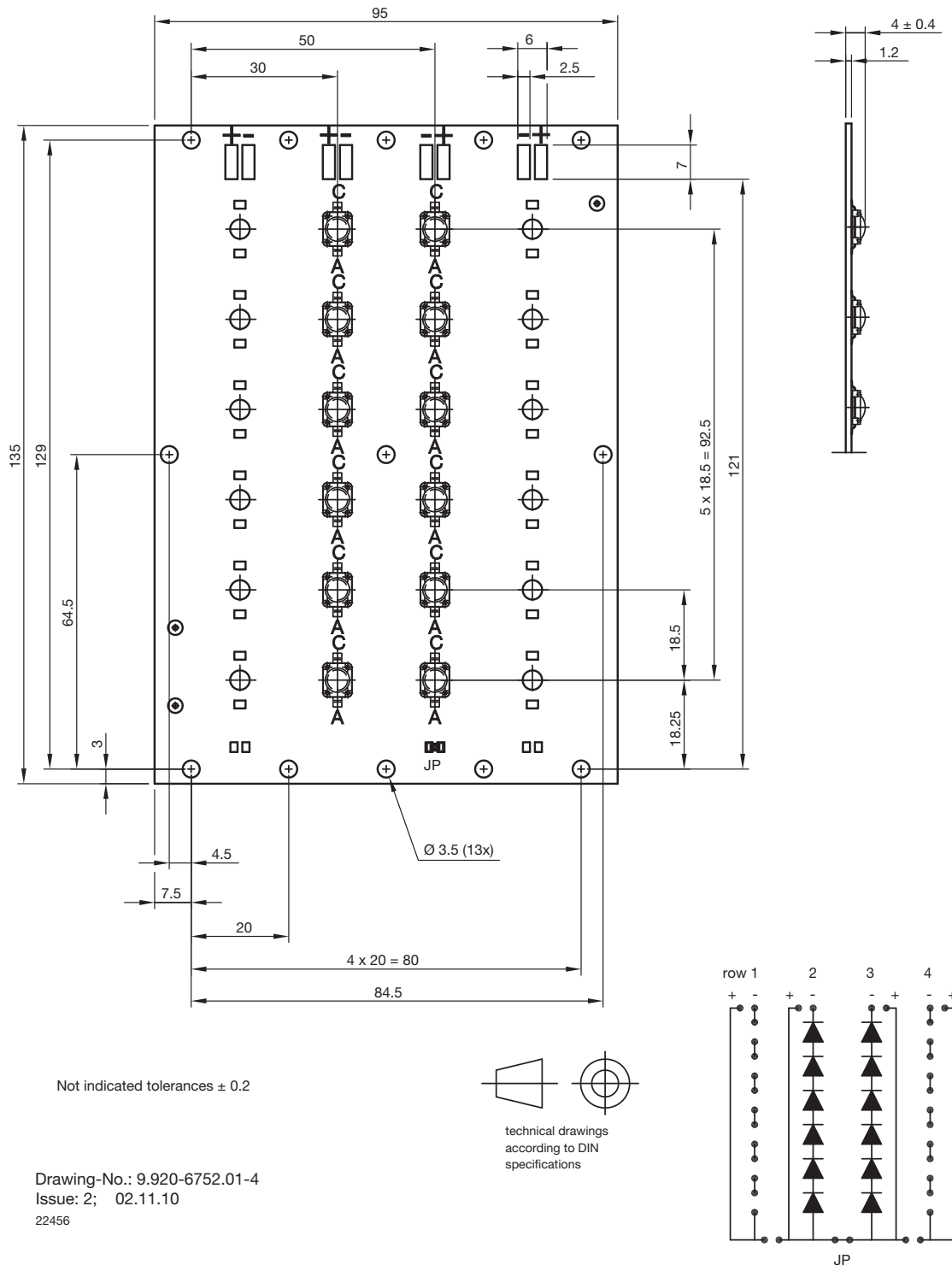
CHROMATICITY COORDINATED GROUPS FOR WHITE SMD LED								
GROUP	X	Y	GROUP	X	Y	GROUP	X	Y
4O	0.386	0.361	4P	0.394	0.365	4Q	0.403	0.369
	0.389	0.369		0.398	0.373		0.406	0.377
	0.398	0.373		0.406	0.377		0.415	0.381
	0.394	0.365		0.403	0.369		0.411	0.373
0.389	0.369	0.398		0.373	0.406		0.377	
5O	0.392	0.377	5P	0.401	0.381	5Q	0.410	0.386
	0.401	0.381		0.410	0.386		0.419	0.390
	0.398	0.373		0.406	0.377		0.415	0.381
	0.392	0.377		0.401	0.381		0.410	0.386
6O	0.394	0.385	6P	0.404	0.390	6Q	0.413	0.394
	0.404	0.390		0.413	0.394		0.422	0.399
	0.401	0.381		0.410	0.386		0.419	0.390
	0.394	0.385		0.404	0.390		0.413	0.394
7O	0.397	0.393	7P	0.407	0.398	7Q	0.416	0.403
	0.407	0.398		0.416	0.403		0.426	0.408
	0.404	0.390		0.413	0.394		0.422	0.399
	0.397	0.393		0.407	0.398		0.416	0.403
8O	0.400	0.401	8P	0.410	0.406	8Q	0.420	0.412
	0.410	0.406		0.420	0.412		0.430	0.417
	0.407	0.398		0.416	0.403		0.426	0.408
	0.400	0.401		0.410	0.406		0.420	0.412
9O	0.402	0.410	9P	0.413	0.415	9Q	0.423	0.420
	0.413	0.415		0.423	0.420		0.434	0.425
	0.410	0.406		0.420	0.412		0.430	0.417
	0.400	0.401		0.410	0.406			

VLSL3212A2, VLSL3224A2



Vishay Semiconductors High Brightness LED Power Module

PCB BASIC DESIGN VLSL3212A2 DIMENSIONS in millimeters



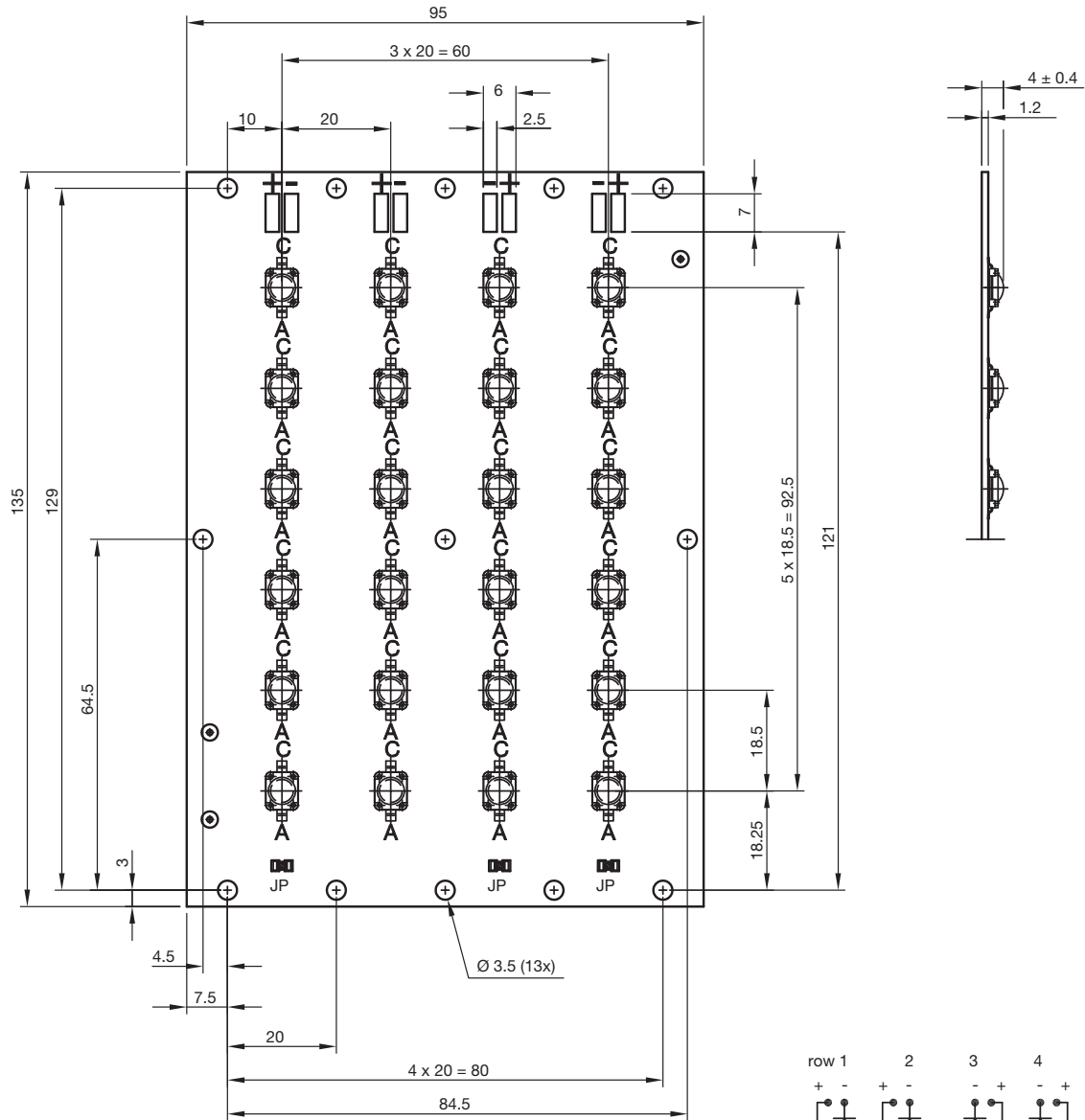
Assembled with all jumpers. Jumpers can be removed according driver design



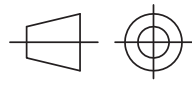
VLSL3212A2, VLSL3224A2

High Brightness LED Power Module Vishay Semiconductors

PCB BASIC DESIGN VLSL3224A2 DIMENSIONS in millimeters

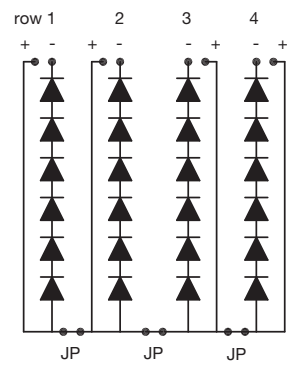


Not indicated tolerances ± 0.2



technical drawings according to DIN specifications

Drawing-No.: 9.920-6751.01-4
Issue: 2; 02.11.10
22455



Assembled with all jumpers. Jumpers can be removed according driver design

PCB CHARACTERISTICS

- Metal core PCB with typical Al thickness of 800 µm
- Prepreg thickness typical 127 µm
- Conductive pattern Cu typical 25 µm
- Total board thickness: 1 mm ± 15 %
- Warpage max. 0.75 % of board dimension
- Solder resist on top side
- Shiny white surface
- Galvanic of solder pads pure matte Sn ($\geq 0.8 \mu\text{m}$), immersion plated
- Assembled with 12 or 24 VLMW91xxx LEDs. LED position accuracy $\pm 0.125 \text{ mm}$ from middle axis, horizontal tilt max. 2°

EMISSION CHARACTERISTIC

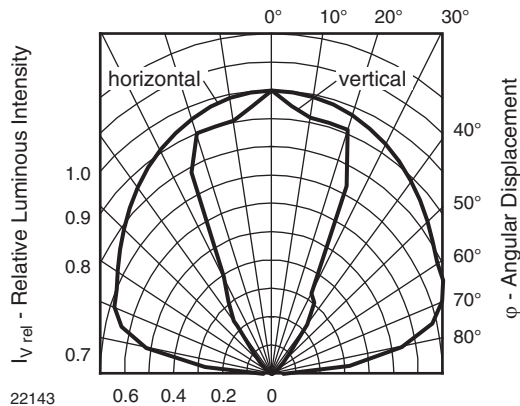
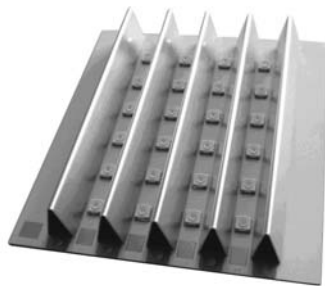


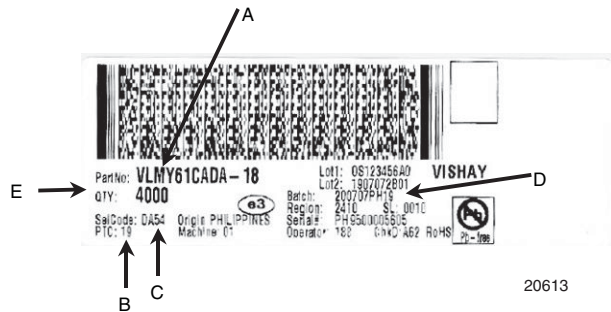
Fig. 2 - Rel. Luminous Intensity vs. Angular Displacement



21853

Fig. 3 - Sample Board with Reflectors (for Info only)

BAR CODE PRODUCT LABEL (example)



20613

- A. Type of component
- B. Manufacturing plant
- C. SEL - selection code (bin):
e.g.: code for V_F class (A, B, C)
- D. Batch:
200707 = year 2007, week 07
PH19 = plant code
- E. Total quantity



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